## STD20200 SCHOTTKY RECTIFIER



Circuit Diagram


## Features

- $150^{\circ} \mathrm{C} \mathrm{T}_{\mathrm{J}}$ operation
- Ultralow forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Trench MOS Schottky technology
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request


## Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection


## Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage <br> Working Peak Reverse Voltage <br> DC Blocking Voltage | $\mathrm{V}_{\mathrm{RRM}}$ <br> $\mathrm{VWM}_{\mathrm{RW}}$ | - | 200 | V |
| Average Rectified Forward Current | $\mathrm{I}_{\mathrm{F}}(\mathrm{AV})$ | $50 \%$ duty cycle @Tc=100 <br> rectangular wave form | 20 | A |
| Peak One Cycle Non-Repetitive Surge <br> Current | $\mathrm{I}_{\text {FSM }}$ | 8.3 ms, Half Sine pulse | 200 | A |

## Electrical Characteristics:

| Characteristics | Symbol | Condition | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Forward Voltage Drop * | $\mathrm{V}_{\mathrm{F} 1}$ | @ 5A, Pulse, $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ <br> @ 10A, Pulse, $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ <br> @ 20A, Pulse, $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | $\begin{aligned} & \hline 0.68 \\ & 0.75 \\ & 0.84 \\ & \hline \end{aligned}$ | $1.10$ | V |
|  | $\mathrm{V}_{\mathrm{F} 2}$ | @ 5A, Pulse, $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ <br> @ 10A, Pulse, $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ <br> @ 20A, Pulse, $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ | $\begin{aligned} & \hline 0.55 \\ & 0.60 \\ & 0.70 \end{aligned}$ | $\begin{gathered} - \\ - \\ 0.72 \\ \hline \end{gathered}$ | V |
| Reverse Current* | $\mathrm{I}_{\mathrm{R} 1}$ | $@ \mathrm{~V}_{\mathrm{R}}=$ rated $\mathrm{V}_{\mathrm{R},} \mathrm{T}_{J}=25^{\circ} \mathrm{C}$ | 0.001 | 0.2 | mA |
|  | IR2 | $@ \mathrm{~V}_{\mathrm{R}}=$ rated $\mathrm{V}_{\mathrm{R},} \mathrm{T}_{J}=125^{\circ} \mathrm{C}$ | 1 | 12 | mA |
| Junction Capacitance | $\mathrm{C}_{\text {T }}$ | $\begin{aligned} & @ V_{\mathrm{R}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=25^{\circ} \mathrm{C} \\ & \mathrm{f}_{\mathrm{SIG}}=1 \mathrm{MHz} \end{aligned}$ | 400 | - | pF |

* Pulse width < $300 \mu \mathrm{~s}$, duty cycle < 2\%
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## Thermal-Mechanical Specifications:

| Characteristics | Symbol | Condition | Specification | Units |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Junction Temperature | $\mathrm{T}_{J}$ | - | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |  |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | - | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |  |
| Typical Thermal Resistance Junction to <br> Case | $\mathrm{R}_{\text {®נc }}$ | DC operation | 2.2 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |
| Approximate Weight | wt | - | 0.39 | g |  |  |
| Case Style |  |  |  |  |  |  |

## Ratings and Characteristics Curves

Figure1


Figure 2


Figure 3
Typical Junction Capacitance 10000


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| SYMBOL | Millimeters |  | Inches |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |
| A | 2.20 | 2.40 | 0.087 | 0.094 |
| A1 | 0.00 | 0.127 | 0.000 | 0.005 |
| b | 0.66 | 0.86 | 0.026 | 0.034 |
| c | 0.46 | 0.60 | 0.018 | 0.024 |
| D | 6.50 | 6.70 | 0.256 | 0.264 |
| D1 | 5.13 | 5.46 | 0.202 | 0.215 |
| D2 | 4.83 REF. |  | 0.190 REF. |  |
| E | 6.00 | 6.20 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.70 | 10.40 | 0.381 | 0.409 |
| L1 | 2.90 REF. |  | 0.144 REF. |  |
| L2 | 1.40 | 1.70 | 0.055 | 0.067 |
| L3 | 1.60 REF. |  | 0.063 REF. |  |
| L4 | 0.60 | 1.00 | 0.024 | 0.039 |
| Ф | 1.10 | 1.30 | 0.043 | 0.051 |
| $\bigcirc$ | $0^{\circ}$ | $8{ }^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |
| h | 0.00 | 0.30 | 0.000 | 0.012 |
| V | 5.35 REF. |  | 0.211 REF. |  |

## Ordering Information

| Device | Package | Shipping |
| :--- | :---: | :---: |
| STD20200 | DPAK | $2500 \mathrm{pcs} /$ reel |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## Marking Diagram



Where $X X X X X$ is $Y Y W W L$

| ST | $=$ Device Type |
| :--- | :--- |
| D | $=$ Package type |
| 20 | $=$ Forward Current (20A) |
| 200 | $=$ Reverse Voltage(200V) |
| SSG | $=$ SSG |
| YY | $=$ Year |
| WW | $=$ Week |
| L | $=$ Lot Number |
| Cautions: | Molding resin |
|  | Epoxy resin UL:94V-0 |

## Carrier Tape Specification DPAK



| SYMBOL | Millimeters |  |
| :---: | :---: | :---: |
|  | Min. | Max. |
| A | 6.80 | 7.00 |
| B | 10.40 | 10.60 |
| C | 2.60 | 2.80 |
| d | $\Phi 1.45$ | $\Phi 1.65$ |
| E | 1.65 | 1.85 |
| F | 7.40 | 7.60 |
| P0 | 3.90 | 4.10 |
| P | 7.90 | 8.10 |
| P1 | 1.90 | 2.10 |
| W | 15.90 | 16.30 |

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